

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KEISUKE KOKIN	04/19/2016
MITSURU MAEDA	04/20/2016
DAISUKE MURAI	04/19/2016
RECEIVING PARTY DATA	
Name:	UNIMATEC CO., LTD.
Street Address:	12-15, SHIBADAIMON 1-CHOME
Internal Address:	MINATO-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	105-0012
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15110579
CORRESPONDENCE DATA	
Fax Number:	(734)994-6331
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	7343026000
Email:	annarbordocketing@brinksgilson.com, dburns@brinksgilson.com
Correspondent Name:	MICHAEL S. GZYBOWSKI
Address Line 1:	524 S. MAIN STREET
Address Line 2:	SUITE 200
Address Line 4:	ANN ARBOR, MICHIGAN 48104-2921
ATTORNEY DOCKET NUMBER:	14056-84
NAME OF SUBMITTER:	MICHAEL S. GZYBOWSKI
SIGNATURE:	/Michael S. Gzybowski/
DATE SIGNED:	07/15/2016
Total Attachments: 1	
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Client Reference No: _____
Attorney Docket No: _____

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- (1) Keisuke KOKIN (3) Daisuke MURAI
- (2) Mitsuru MAEDA (4) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto UNIMATEC CO., LTD., an organization existing under the laws of Japan having its principal office and place of business address located at 12-15, Shibadaimon 1-chome, Minato-ku, Tokyo, JAPAN, and its successors and assign (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

PERFLUOROVINYLOXY POLYETHER CARBOXYLIC ACID ALKALI METAL SALT AND METHOD FOR PRODUCING THE SAME

- (a) for which an application for United States Letters Patent was filed on _____, and identified by United States Serial No. _____; or
- (b) for which an international application designating the United States was filed on _____, and identified by International Application No. _____; or
- (c) for which an application for United States Letters Patent was executed on _____,

and the right to all benefits under the International Convention of the Protection of Industrial Property to said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; together with the right to recover all damages, including, but not limited to, a reasonable royalty, by reason of past, present, or future infringement or any violation of patent or patent application rights; to have and to hold for the sole and exclusive use and benefit of the ASSIGNEE, its successors and assigns, to the full end of the term or terms for all such patents;

The undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patents which may be granted therefore and any and all extensions, divisions, reissues, substitutes, continuations, or continuations-in-part thereof.

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissue or extended Letters Patent of the United States upon request of said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to said invention; assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

<u>INVENTORS</u>	<u>DATE SIGNED</u>
1) <u>Keisuke Koki</u> Name: Keisuke KOKIN	<u>April. 19. 2016</u>
2) <u>Mitsuru Maeda</u> Name: Mitsuru MAEDA	<u>April. 20. 2016</u>
3) <u>Daisuke Murai</u> Name: Daisuke MURAI	<u>April. 19. 2016</u>

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